

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Byung Hoon AHN	12/02/2004
Pandi Chelvam MARIMUTHU	12/02/2004
RECEIVING PARTY DATA	
Name:	STATS CHIPPAK LTD.
Street Address:	5 Yishun St. 23
City:	Singapore 768442
State/Country:	SINGAPORE
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11007896
CORRESPONDENCE DATA	
Fax Number:	(408)738-0881
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	408-738-0592
Email:	tami@ishimarulaw.com
Correspondent Name:	Mikio Ishimaru
Address Line 1:	The Law Offices of Mikio Ishimaru
Address Line 2:	1110 Sunnyvale-Saratoga Rd., Ste. A1
Address Line 4:	Sunnyvale, CALIFORNIA 94087
NAME OF SUBMITTER:	Mikio Ishimaru
Total Attachments: 2 source=27-077 Assignment#page1.tif source=27-077 Assignment#page2.tif	

CH \$40.00 11007896

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PATENT
REEL: 015680 FRAME: 0601

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT LEADFRAME AND FABRICATION METHOD THEREFOR


for which a United States patent application has been executed on or before the date of this assignment;


WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 5 Yishun Street 23, Singapore 768442 (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee, the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee where said Assignee may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee) which are deemed necessary or desirable by Assignee to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee) which are deemed necessary or desirable by assignee for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee.
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee, its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



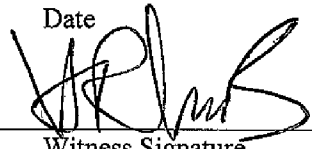
Byung Hoon Ahn


Witness Signature
Jang Tae Hoan

Print Witness Name
2. Dec. 2004.

Date

Dec. 02 '04

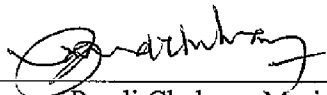
Date


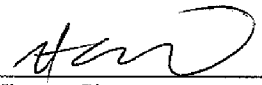
Witness Signature
H.R. Hu

Print Witness Name
2. Dec. 2004

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



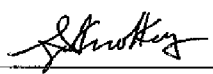
Pandi Chelvam Marimuthu


Witness Signature
KU JAE HUN

Print Witness Name
2 Dec 04

Date

2 Dec '04

Date


Witness Signature
Sze To Kwok Keung

Print Witness Name
2 Dec 04

Date
